ASSOCIATION CONNECTING LECTRONICS INDUSTRIES international and Pan-American	kburn, Illinois, A	Ill rights reserved untions.	under both	This docume level parts, t	ent is a declarat he declaration e	ion of the su	ibstances s all lower	within the manufactur level materials for wl	er listed i hich the n	tem. Note: nanufacture	if the item is an as er has engineering	sembly with lower responsibility.	
1752-21.1 IPC Web Site for Information o http://www.ipc.org/IPC-175x	.1 IPC Web Site for Information on IPC-1752 Standard Form Ty Distribut				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materia					als and Mfg Information			
Supplier Information													
Company name*	npany name* Company unique ID			Unique ID Authority					Response Date*				
mi									2023-06-08				
Contact Name	Title - Contact				Phone - Contact*				Email - Contact*				
Product-Env-Stewards	uct-Env-Stewards Product Enviro Compliance			NA				Product-Env-Stewards@onsemi.com					
uthorized Representative* Title - Representative				Phone - Representative*				Email - Representative*					
Product-Env-Stewards Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com					
Requester Item Number Mfr It	em Number	Mfr Item Name			Effective Date	Version	N	Manufacturing Site		Weight*	UOM	Unit Type	
FODM NF09	3012R2V- 4SO RP TRIAC T&		T&R VDE		2023-06-08 L		LITEONFG		74.91	mg	Each		
Manufacturing Proccess Information													
Terminal Plating / Grid Array Material	Terminal Base	Ferminal Base Alloy J-		Rating	Peak Proc	Process Body Temperature Max Time at Peak		Temperature Number of Reflow Cycles		les			
Matte Tin (Sn) - annealed	Matte Tin (Sn) - annealed CU Alloy		1		260	C 30		30	seconds 3		-		
Comments													
level 1 - maximum time at peak temperature during	soldering is 10-3	0 seconds											
For more information regarding material composition	n please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).									
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of					
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted						
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all					
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the					
Supplier Digital Signature Ra	stislav Drska	Le								

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Coupling Gel	1.0	mg	Supplier	Titanium Dioxide (TiO2)	13463-67-7		0.45	mg
			Supplier	Dimethyl Cyclosiloxanes	69430-24-6		0.1	mg
			Supplier	Trimethoxy(methyl)silane (C4H12O3Si)	1185-55-3		0.45	mg
Die	0.237	mg	В	Gallium Arsenide (AsGa)	1303-00-0		0.077	mg
			Supplier	Silicon (Si)	7440-21-3		0.16	mg
Die Attach	0.17	mg	Supplier	Silver (Ag)	7440-22-4		0.1326	mg
			Supplier	Phenolic Resin-2	54208-63-8		0.0374	mg
Lead Frame	22.5	mg	Supplier	Silver (Ag)	7440-22-4		0.0022	mg
			Supplier	Zinc (Zn)	7440-66-6		0.027	mg
			Supplier	Iron (Fe)	7439-89-6		0.5175	mg
			Supplier	Copper (Cu)	7440-50-8		21.9465	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0067	mg
Mold Compound-Black	27.9	mg	Supplier	2,6-dibromo-4-[1-(3-bromo-4- hydroxyphenyl)-1-methylethyl]phenol	6386-73-8		1.1149	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		6.4275	mg
			В	Antimony Trioxide (Sb2O3)	1309-64-4		0.8372	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		19.5205	mg
Mold Compound-White	21.1	mg	Supplier	Ortho Cresol Novolac Resin	29690-82-2		4.22	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		14.77	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		2.11	mg
lating	1.95	mg	Supplier	Tin (Sn)	7440-31-5		1.95	mg
Wire Bond - Au	0.053	mg	Supplier	Gold (Au)	7440-57-5		0.053	mg